



I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled POLYSILICON ETCH USEFUL DURING THE MANUFACTURE OF A SEMICONDUCTOR DEVICE, the specification of which:

JF.	ACTURE OF A SEMICONDUCTOR	DL	rez, ass					
X	is attached hereto.	icatio	n Serial No.		·			
	was filed on, as App.	and	understand	the	contents	of	the	abov

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims.

I acknowledge the duty to disclose information which is material to patentability of the subject matter claimed in this application as "materiality" is defined in Title 37 of the Code of Federal

I hereby claim the benefit of any earlier filing date in the United States to which I am entitled Regulations, § 1.56. under Title 35 of the United States Code, § 120 and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35 of the United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37 of the Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(Status) (Filing Date) (Application Serial No.)

Send correspondence to:

Kevin D. Martin, Mail Stop 525 Micron Technology, Inc. 8000 S. Federal Way Boise, Idaho 83706 (208) 368-4516

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

David J. Keller Full name of first or sole inventor:

(First, Middle Initial, Last) Inventor's Signature:

12-8-99 Date:

Residence Address:

1948 Manitou City, State, Country:

Boise, ID 83706 United States of America

United States

Citizenship: Same as residence address Post Office Address:

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE							
In re Application of: David J. Keller	§ Atty. Docket: 99-0738						
Serial No.: Unknown	"EXPRESS MAIL" MAILING LABEL NUMBER EL003002270US DATE OF DEPOSIT /2/10/99 THEREBY CERTIFY THAT THIS PAPER IS BEING DEPOSITED WITH						
Filed: Concurrently Herewith	§ THE UNITED STATES POSTAL SERVICE "EXPRESS MALE 1 001						
For: POLYSILICON ETCH USEFUL DURING THE MANUFACTURE OF A SEMICONDUCTOR DEVICE	S OFFICE TO ADDRESSEE SERVICE ONDER ADDRESSED TO THE DATE INDICATED ABOVE AND IS ADDRESSED TO THE ASSISTANT COMMISSIONER FOR PATENTS, WASHINGTON, D.C. 20231.						
	Cay / /						
ELECTION UNDER 37 C.F.R. §§ 3.71 AND 3.73 AND POWER OF ATTORNEY							
Assistant Commissioner for Patents Washington, D.C. 20231							

Dear Sir:

The undersigned, being Assignee of the entire interest in the above-identified application by virtue of an Assignment recorded in the United States Patent and Trademark Office as set forth below or filed herewith, hereby elects, under 37 C.F.R. § 3.71, to prosecute the application to the exclusion of the inventor(s).

The Assignee hereby revokes any previous Powers of Attorney and appoints: Michael L. Lynch, Reg. No. 30,871; Lia M. Pappas, Reg. No. 34,095; Walter D. Fields, Reg. No. 37,130; Charles B. Brantley, II, Reg. No. 38,086; Kevin D. Martin, Reg. No. 37,882; and David J. Paul, Reg. No. 34,692 as its attorney or agent, with full power of substitution and revocation, to prosecute the application, to make alterations and amendments therein, to transact all business in the Patent and Trademark Office in connection therewith, to receive any Letters Patent, and for one year after issuance of such Letters Patent to file any request for a certificate of correction that may be deemed appropriate.

Pursuant to 37 C.F.R. § 3.73, the undersigned duly authorized designee of Assignee certifies the evidentiary documents have been reviewed, specifically MICRON TECHNOLOGY, INC., referenced below, and certifies that to the best of my knowledge and belief, title remains in the name of the Assignee.

Please direct all communications as follows:				
Kevin D. Martin, Mail Stop 525				
MICRON TECHNOLOGY, INC. 8000 S. Federal Way				
Boise, ID 83706-9632				
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GNEE: MICRON TECHNOLOGY, INC.				
By: Michael L. Lynch, Reg. No. 30,871				
Chief Patent Counsel				